

Measurement condition

Ambient temperature: 23 °C

Input power level: 0 dBm

Terminating impedances at f_c *:
input: 84 Ω // -5,40 pF
output: 84 Ω // -5,40 pF**Characteristics****Remark:**

Reference level for the relative attenuation a_{rel} of the TFS 434 is the minimum of the pass band attenuation a_{min} . The minimum of the pass band attenuation a_{min} is defined as the insertion loss a_e . The centre frequency f_c is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss a_e . The nominal frequency f_N is fixed at 434 MHz without tolerance. The given values for the relative attenuation a_{rel} and for the group delay ripple have to be reached at the frequencies given below even if the centre frequency f_c is shifted due to the temperature coefficient of frequency TC_f in the operating temperature range and due to a production tolerance for the centre frequency f_c .

D a t a		typ. Value		Limit	
Insertion loss (Reference level)	a_e	2,60	dB	max.	3,5 dB
Nominal frequency	f_N	-		434	MHz
1 dB - bandwidth	BW	480	kHz	min.	400 kHz
Relative attenuation	a_{rel}				
f_N	$\dots\dots f_N \pm 0,2$ MHz	0,50	dB	max.	1 dB
$f_N - 1$ MHz	$\dots\dots f_N - 6$ MHz	22	dB	min.	15 dB
$f_N - 6$ MHz	$\dots\dots f_N - 20$ MHz	45	dB	min.	40 dB
$f_N - 20$ MHz	$\dots\dots f_N - 424$ MHz	63	dB	min.	45 dB
$f_N + 1$ MHz	$\dots\dots f_N + 8$ MHz	13	dB	min.	10 dB
$f_N + 8$ MHz	$\dots\dots f_N + 116$ MHz	47	dB	min.	35 dB
$f_N + 116$ MHz	$\dots\dots f_N + 566$ MHz	55	dB	min.	45 dB
Input power level		-		max.	0 dBm
Temperature coefficient of frequency TC_f **		- 0,036	ppm/K ²	-	
Turn over temperature		10	°C	-	
Operating temperature range		-		- 25 °C.. + 80	°C
Storage temperature range		-		- 35 °C.. + 85	°C

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

**) $\Delta f(\text{Hz}) = TC_f(\text{ppm/K}^2) \times (\Delta T)^2 \times f_{T0}(\text{MHz})$

generated: _____

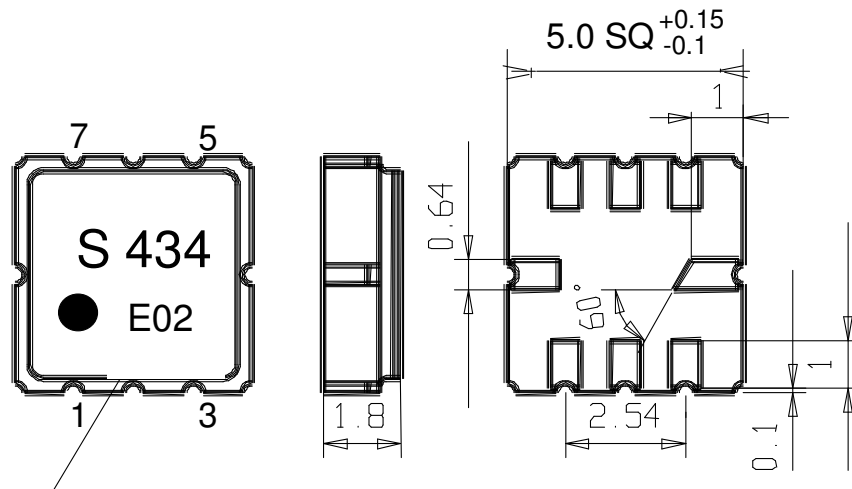
checked / approved: _____

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Construction and Pin Connection

(All dimensions in mm)

**Date code**

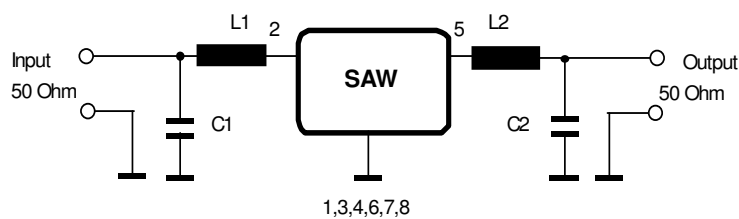
date code: year + week

Pin 1 Input RF Return
 Pin 2 Input
 Pin 3 Ground
 Pin 4,8 Package Ground

Pin 5 Output
 Pin 6 Output RF Return
 Pin 7 Ground

E 2014
 F 2015
 G 2016

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50 Ω matching circuit:

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Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0.35 mm or g respectively, 1 octave per min, 10 cycles per plane, 3 planes; DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125 °C / 15 min. each / 100 cycles
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: three times max.;
for temperature conditions, see page 4: "Air reflow temperature conditions"

This filter is RoHS compliant (2011/65/EU)

Packing

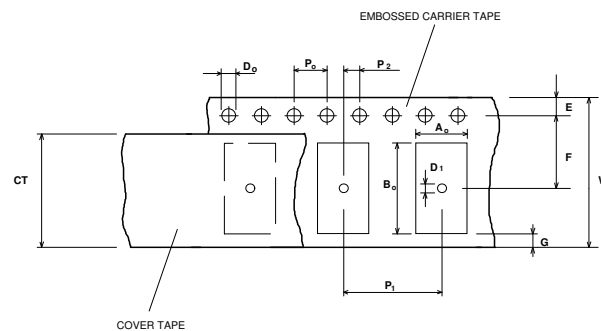
Tape & Reel: DIN IEC 286 – 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

max. pieces of filters per reel:
reel of empty components at start:
reel of empty components at start including leader:
trailer

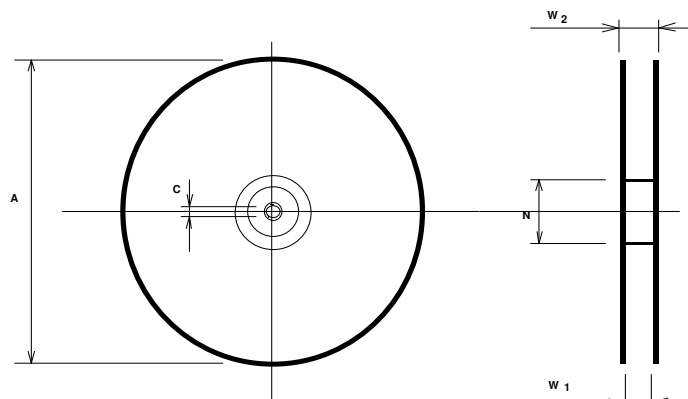
3000
min 300 mm
min 500 mm
min 300 mm

Tape (all dimensions in mm)

W	: 12	± 0,3
Po	: 4	± 0,1
Do	: 1,5	+ 0,1
E	: 1,75	± 0,1
F	: 5,5	± 0,05
G (min)	: 0,75	
P2	: 2	± 0,05
P1	: 8	± 0,1
D1(min)	: 1,5	
Ao	: 5,3	± 0,1
Bo	: 5,3	± 0,1
CT	: 9,5	± 0,1

**Reel (all dimensions in mm):**

A	: 330
W1	: 12,4 + 2
W2 (max)	: 18,4
N (min)	: 50
C	: 13 +0,5 -0,2



The minimum bending radius is 45 mm. The mounting surface of the filters faces the bottom side of the embossed carrier tape. Markings on the filters can be read if the upper side of the carrier tape is regarded with the sprocket holes on its right.

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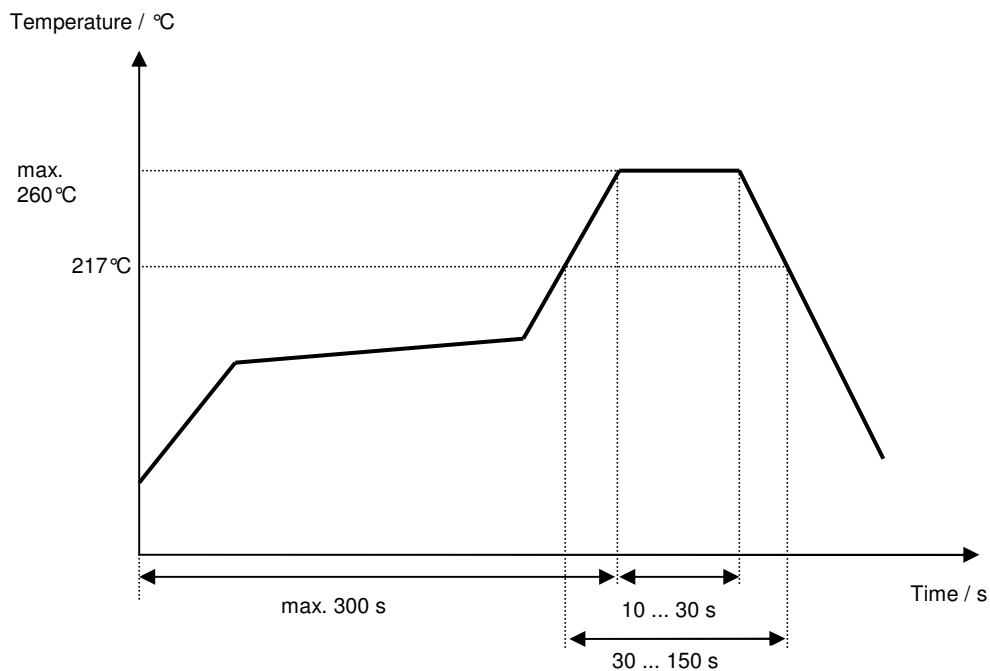
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Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile

History

Version	Reason of Changes	Name	Date
1.0	generate specification	Pfeiffer	13.09.2002
1.1	change 1 dB-bandwidth	Pfeiffer	20.09.2002
1.2	filter specification, add of all typical values correct of input pin	Dr. Sabah	07.01.2003
1.3	maximum input power updated	Kortenbeutel	07.01.2014